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III-Nitrides Semiconductor Research in the UK and Ireland

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Deadline for manuscript submissions:

closed (6 July 2018)

Message from the Guest Editors

Dear Colleagues,

Since 1994, III-nitrides researchers in the UK and Ireland have shared their research results and expertise through the UK Nitrides Consortium (UKNC, http://www.uknc.org/). Now comprising about 200 workers spread over 23 academic and commercial centres of excellence, UKNC convenes formally twice a year at well-attended Summer and Winter Conferences. This Special Issue provides a snapshot of the most recent Winter Conference, held at the University of Manchester on 10–11 January, 2018, with selected contributions from the main players on a range of topics, including photonics and nanostructures, novel nitrides, materials characterisation, as well as electronic and optoelectronic devices and systems.

Prof. Dr. Kevin P. O'Donnell Guest Editor













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Message from the Editor-in-Chief

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